TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS III)

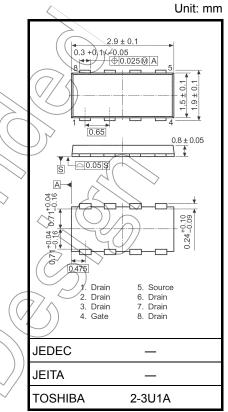
# **TPCF8102**

### Notebook PC Applications Portable Equipment Applications

- Low drain-source ON resistance: R<sub>DS (ON)</sub> = 24 mΩ (typ.)
- High forward transfer admittance: |Y<sub>fs</sub>| = 14 S (typ.)
- Low leakage current  $: I_{DSS} = -10 \ \mu A \ (max) \ (V_{DS} = -20 \ V)$
- Enhancement mode :  $V_{th} = -0.5$  to -1.2 V
  - $(V_{DS} = -10 \text{ V}, I_D = -200 \text{ }\mu\text{A})$

### Absolute Maximum Ratings (Ta = 25°C)

(unit)
y
V
V
٨
W
w
μJ
A
mJ
°C
°C
×



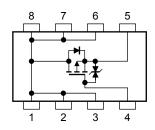
Weight: 0.011 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	R <sub>th (ch-a)</sub>	50.0	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R <sub>th (ch-a)</sub>	178.6	°C/W

### **Circuit Configuration**



Note: (Note 1), (Note 2), (Note 3) and (Note 4): See the third page.

This transistor is an electrostatic-sensitive device. Please handle with caution.

Electrical Characteristics (Ta = 25°C)

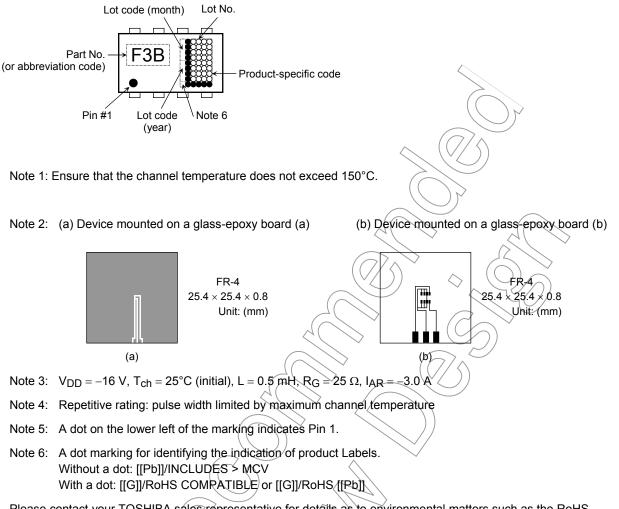
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage current		I <sub>GSS</sub>	$V_{GS} = \pm 8 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	_		±10	μA	
Drain cut-off current		I <sub>DSS</sub>	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_	_	-10	μA	
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-20	_		V	
		V (BR) DSX	$I_D = -10 \text{ mA}, V_{GS} = 8 \text{ V}$	12			v	
Gate threshold v	oltage	V <sub>th</sub>	$V_{DS} = -10 \text{ V}, I_D = -200 \ \mu\text{A}$	-0.5		-1.2	V	
Drain-source ON resistance		R <sub>DS (ON)</sub>	$V_{GS} = -1.8 \text{ V}, I_D = -1.5 \text{ A}$		67	90		
		R <sub>DS (ON)</sub>	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -3.0 \text{ A}$	$\mathcal{A}$	36	41	mΩ	
		R <sub>DS (ON)</sub>	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.0 \text{ A}$		24	30		
Forward transfer	Forward transfer admittance		$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -3.0 \text{ A}$	7	14		S	
Input capacitance		C <sub>iss</sub>			1550			
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -10 V, V_{GS} = 0 V, f = 1 MHz$		215	$\rightarrow$	pF	
Output capacitance		C <sub>oss</sub>	$( \gamma )$	-6	265	> -		
Switching time	Rise time	tr	0/7 [ ID = -3.0 A	UV V		) —		
	Turn-on time	t <sub>on</sub>			13		20	
	Fall time	t <sub>f</sub>			21		ns	
	Turn-off time	toff	$V_{DD} \approx -10 \text{ V}$ Duty $\leq 1\%$ , t <sub>w</sub> $\neq 10 \text{ µs}$	/	68			
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq -16 \text{ V}, \text{ V}_{GS} = -5 \text{ V},$		19			
Gate-source charge		Qgs	$I_{\rm D} = -6.0 \rm{A}$	_	14	_	nC	
Gate-drain ("miller") charge		Qgd		_	5	_		

# Source-Drain Ratings and Characteristics (Ta = 25°C)

Charac	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)		-	_	_	-24	А
Forward voltage (diode) VDSF		V <sub>DSF</sub>	$I_{DR} = -6.0 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	1.2	V
/		$\sim$	$\checkmark$				

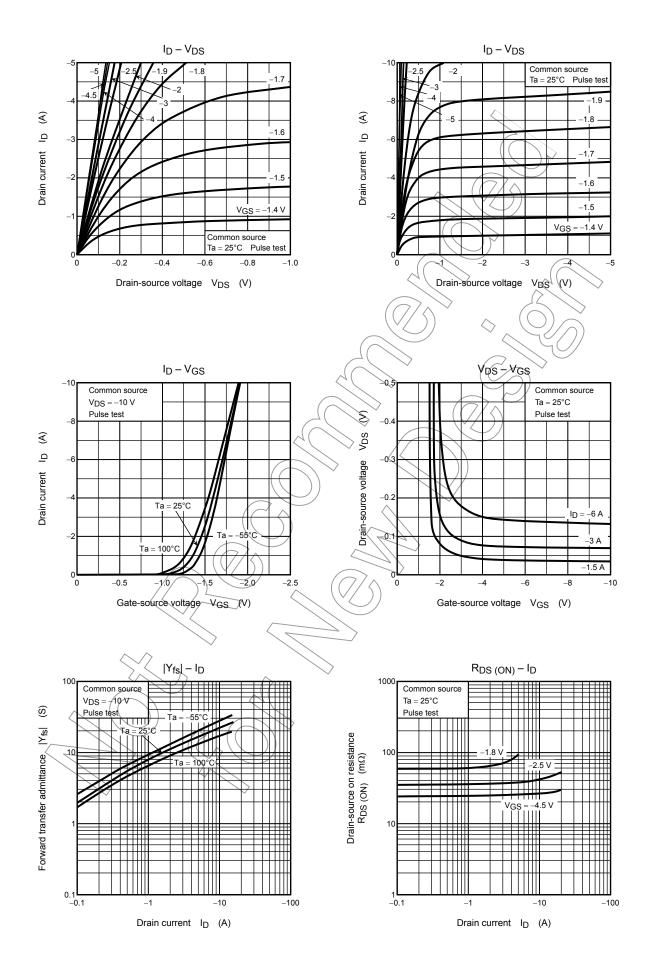
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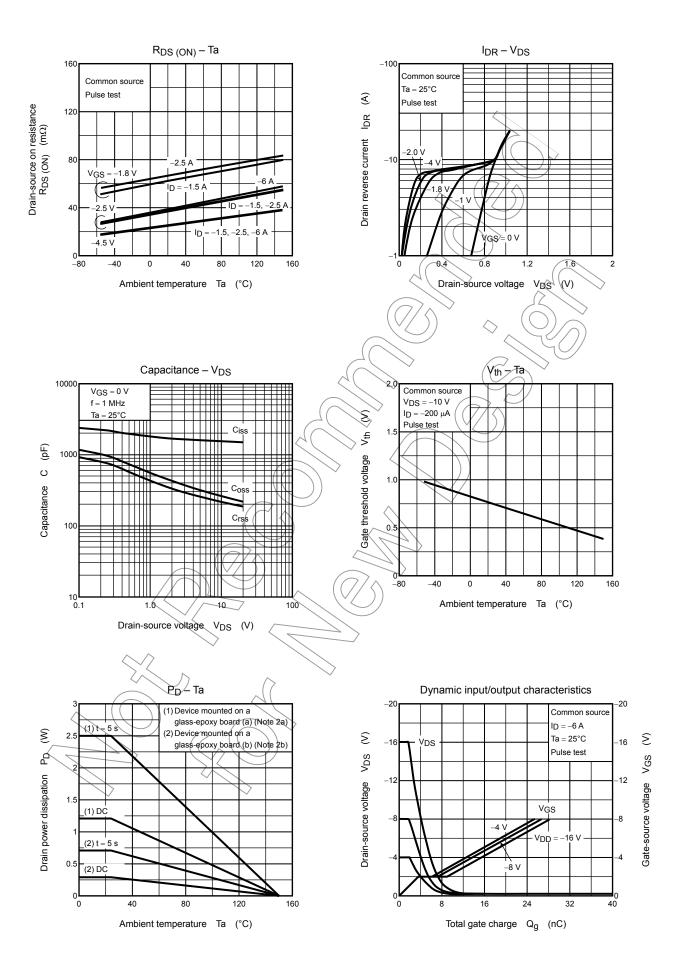
### Marking (Note 5)

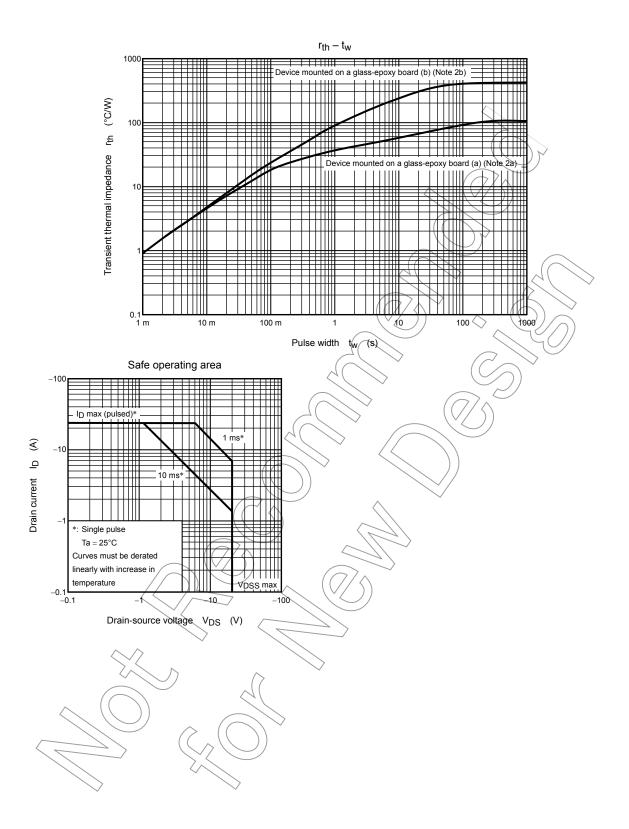


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